



Union Internationale Pour La Science, La Technique et Les Applications du Vide
International Union for Vacuum Science, Technique and Applications
Internationale Union für Vakuum Forschung, Technik und Anwendung



Dear colleagues and friends of ICTF Conference series,

Last opportunity for Abstract submission to attend [19th International Conference on Thin Films \(ICTF2023, September 26th - 29th 2023, Burgos, Spain\)](#) is approaching !!! **(final deadline for abstract submission April 30th)**

The ICTF is a well-established conference series for researchers interested in **thin films and coatings**. It is organised after every three years and supported by the Thin Film Division of the International Union for Vacuum Science, Technique and Applications (IUVSTA). This edition is also supported by the Spanish Vacuum Society (ASEVA).

PLENARY SPEAKERS

[AKHLESH LAKHTAKIA](#) (Pennsylvania State University, USA)

[MAR GARCÍA HERNÁNDEZ](#) (Materials Science Institute of Madrid, Spain)

[JIRI HOMOLA](#) (Charles University, Czech Republic)

[ANA I. BORRÁS](#) (Materials Science Institute of Sevilla, Spain)

SOCIAL EVENT

Visit to the [Archeological site of Atapuerca](#)

SATELLITE ACTIVITY

QUASES XPS Master Class by Prof. Sven Tougaard

For more information and further updates, please visit the [conference website](#).

We invite you to join us at ICTF2023 !

Yours sincerely

F Yubero

I Palacio

Conference Chairs ICTF-2023

<https://icf2023.com/>

Important dates	
March 1st, 2023	Start abstract submission
April 30th, 2023	Deadline abstract submission
May 15th, 2023	Abstract notification
May 16th, 2023	Registration opening
June 15th, 2023	Deadline early registration
September 26th, 2023	Conference starts